

Intelli-Phase[™] Solution (Integrated HS/LS FETs and Driver) in 6x6mm TQFN

DESCRIPTION

The MP86883 is a monolithic half-bridge with built-in internal power MOSFETs and gate drivers. It achieves 55A of continuous output current over a wide input supply range.

Integration of the driver and MOSFETS results in high efficiency due to optimal dead time control and parasitic inductance reduction.

The MP86883 is a Monolithic IC approach to drive up to 55A per phase. This very small TQFN-34 (6mm x 6mm) device can operate from 100kHz to 1MHz.

This device works with tri-state output controllers. It also comes with a general-purpose current sense and temperature sense.

The MP86883 is ideal for server applications where efficiency and small size are a premium.

FEATURES

- Wide 4.5V to 14V Operating Input Range
- Simple Logic Interface
- 55A Output Current
- Accepts Tri-State PWM Signal
- Built-In Switch for Bootstrap
- Current Sense
- Current Limit Protection
- Temperature Sense and Protection
- Fault Reporting
- Used for Multi-Phase Operation
- Available in TQFN-34 (6mm x 6mm)
 Package

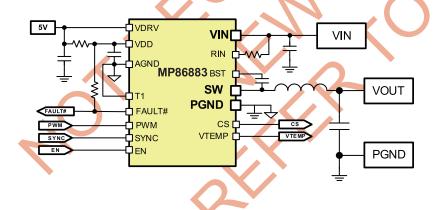
APPLICATIONS

- Server/Workstation/Desktop Core Voltage
- Graphic Card Core Regulators
- Power Modules

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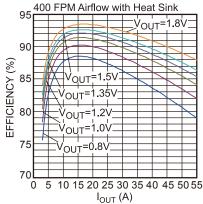
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TYPICAL APPLICATION



System Efficiency vs. Output Current

L= FP1007R3-R21,



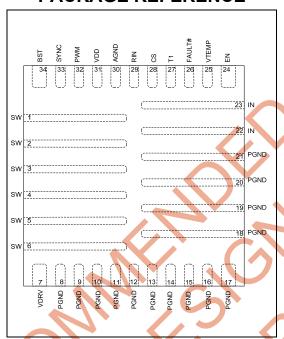


ORDERING INFORMATION

Part Number*	Package	Top Marking
MP86883GQKT	TQFN-34 (6mmx6mm)	MP86883

^{*} For Tape & Reel, add suffix -Z (e.g. MP86883GQKT-Z);

PACKAGE REFERENCE



ABSOLUTE MAXIMUM RATINGS (1)

Supply Voltage V _{IN}	16V
V _{SW (DC)}	1 V to 16V
V _{SW (25ns)}	3V to 23V
V _{BST}	V _{SW} + 6V
All Other Pins	0.3V to +6V
Instantaneous Current	100A
Continuous Power Dissipation	$(T_A = +25^{\circ}C)^{(2)}$
	4.3W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature6	

Recommended Operating Conditions (3)

Supply Voltage V _{IN}	4.5V to 14V
Driver Voltage V _{DRV}	4.5V to 5.5V
Logic Voltage V _{DD}	4.5V to 5.5V
Operating Junction Temp. (TJ)40°C to +125°C

Thermal Resistance (4) θ_{JA} θ_{JC} TQFN-34 (6mmx6mm)......29.....8....°C/W

Notes:

- Exceeding these ratings may damage the device.
- The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance $\theta_{JA},$ and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J) $(MAX)-T_A)/\theta_{JA}$. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- Measured on JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS (5)

 V_{IN} = 12V, V_{DRV} = V_{DD} =5V, T_A = -40°C to 125°C, unless otherwise noted.

	Parameters	Symbol	Condition	Min	Тур	Max	Units	
In Standby	I _{IN} Shutdown		V _{DRV} =V _{DD} =0V				μA	
Threshold Rising	I _{IN} Standby	_			60		μA	
Threshold Hysteresis IDRV Quiescent Current IDRV Shutdown 250 IDRV Shutdown IDRV Shutd					4	4.4	V	
IDRV Shutdown Current					300		mV	
IDD Quiescent Current IDD (Quiescent) PWM=Low 2.4 IDD Shutdown Current IDD Shutdown 70 VDD Voltage UVLO Rising 4 4.4 VDD Voltage UVLO Hysteresis 300 High Side Current Limit(5) ILIM 80 Low Side Current Limit(5) ILIM 80 Low Side Current Limit(6) -30 EN Input Low Voltage 2 EN Input High Voltage 2 Dead-Time Rising(6) 8 SYNC Current ISYNC VSYNC=0V -65 SYNC Logic High Voltage 2 SYNC Logic Low Voltage 9 0.4 PWM High to SW Rising Delay(5) 35 PWM Low to SW Falling Delay(5) 35 PWM Tristate to SW Hi-Z Delay(5) 1tr 50 Minimum PWM Pulse Width(6) 30 Current Sense Accuracy(6) Iouт=30A ±4 Current Sense Gain 10 Temperature Sense Gfiset(6) -100 Over Temperature Hysteresis(5) 170 Over Temperature Hysteresis(5) 10 PWM Input Current 1 A 4 4 4 4 4 4 4 5 4 5 4 6 4 7 4 8 4 8 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 4 4 4 9 5 6 0 7 0 7 0 7 0 7 0 8 0 8 0 9 0		I _{DRV} (Quiescent)	PWM=Low			500	μΑ	
IDD Shutdown Current	IDRV Shutdown Current	DRV Shutdown					μΑ	
VDD Voltage UVLO Rising	I _{DD} Quiescent Current	I _{DD} (Quiescent)	PWM=Low		2.4		mA	
VDD Voltage UVLO Hysteresis	I _{DD} Shutdown Current	I _{DD} Shutdown			70		μΑ	
High Side Current Limit(5)	VDD Voltage UVLO Rising				4	4.4	V	
Low Side Current Limit(5)	VDD Voltage UVLO Hysteresis				300		mV	
EN Input Low Voltage EN Input High Voltage Dead-Time Rising(5) Dead-Time Falling(5) SYNC Current SYNC Lorgic High Voltage SYNC Logic Low Voltage PWM High to SW Rising Delay(5) PWM Low to SW Falling Delay(5) FWM Tristate to SW Hi-Z Delay(5) Minimum PWM Pulse Width(5) Current Sense Accuracy(6) Current Sense Accuracy(6) Temperature Sense Gain Temperature Sense Gain(8) Temperature Sense Offset(6) Over Temperature Hysteresis(5) EN Out 1	High Side Current Limit ⁽⁵⁾	I _{LIM}			80		Α	
EN Input High Voltage	Low Side Current Limit ⁽⁵⁾				-30		Α	
Dead-Time Rising(5) 3 Dead-Time Falling(5) 8 SYNC Current Isync Vsync=0V SYNC Logic High Voltage 2 SYNC Logic Low Voltage 0.4 PWM High to SW Rising Delay(5) 35 PWM Low to SW Falling Delay(5) 35 PWM Tristate to SW Hi-Z Delay(5) ttT 60 Minimum PWM Pulse Width(5) 50 50 Current Sense Accuracy(5) Iour=30A ±4 Current Sense Gain 10 n Temperature Sense Gain(6) 10 n Temperature Sense Offset(6) -100 o Over Temperature Hysteresis(5) 30 VPWM=3.3V, VEN=5V 95	EN Input Low Voltage					0.4	V	
Dead-Time Falling(5) 8 SYNC Current IsyNC VsyNC=0V -65 SYNC Logic High Voltage 2 SYNC Logic Low Voltage 2 9.4 PWM High to SW Rising Delay(5) 35 PWM Low to SW Falling Delay(5) 35 1 1 1 1 1 1 1 1 1	EN Input High Voltage			2			V	
SYNC Current SYNC	Dead-Time Rising ⁽⁵⁾				3		ns	
SYNC Current SYNC	Dead-Time Falling ⁽⁵⁾				8		ns	
SYNC Logic High Voltage 2 SYNC Logic Low Voltage 0.4 PWM High to SW Rising Delay ⁽⁵⁾ 35 PWM Low to SW Falling Delay ⁽⁵⁾ 35 PWM Tristate to SW Hi-Z Delay ⁽⁶⁾ ttr 50 Minimum PWM Pulse Width ⁽⁶⁾ 30 50 Current Sense Accuracy ⁽⁶⁾ Iouт=30A ±4 Current Sense Gain 10 n Temperature Sense Offset ⁽⁶⁾ 10 n Over Temperature Flag ⁽⁵⁾ 170 0 Over Temperature Hysteresis ⁽⁵⁾ 30 V _{PWM} =3.3V, V _{EN} =5V 95		Isync	V _{SYNC} =0V		-65		μA	
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Temperature Sense Offset ⁽⁶⁾ -100 Over Temperature Flag ⁽⁵⁾ 170 Over Temperature Hysteresis ⁽⁵⁾ 30 PWM Input Current I _{PWM} V _{PWM} =3.3V, V _{EN} =5V 95							μΑ/Α mV/°C	
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PWM Input Current I _{PWM} V _{EN} =5V 95	Over Temperature Hysteresis(5)				30		°C	
V _{PWM} =0V, V _{EN} =5V -95	PWM Input Current	1 _{PWM}	V _{EN} =5V				μA	
			V _{PWM} =0V, V _{EN} =5V		-95		μΑ	
PWM Logic High Voltage 2.65		·					V	
PWM Tristate Region ⁽⁵⁾ 1 1.7				1			V	
PWM Logic Low Voltage 0.40 Notes:						0.40	V	

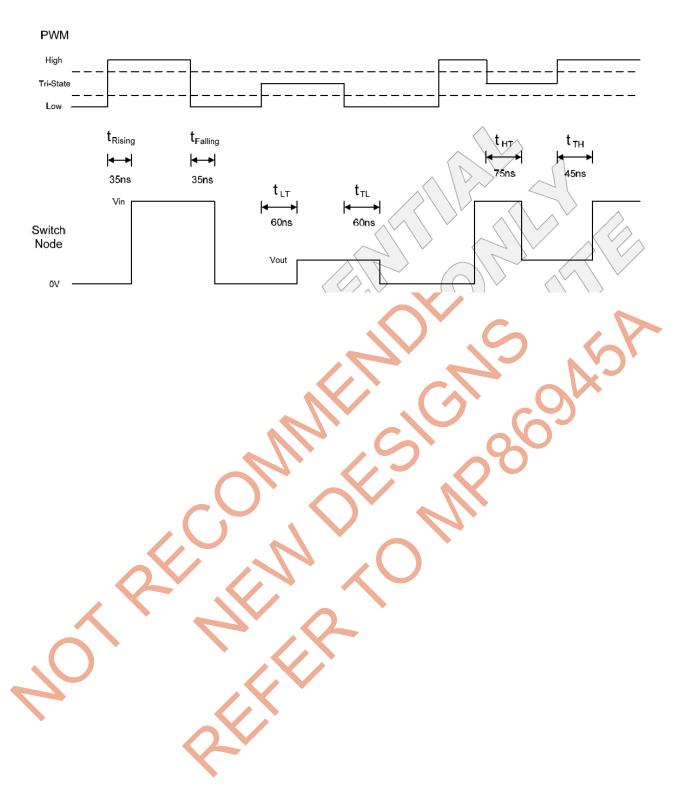
Notes:

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⁵⁾ Guaranteed by design.

⁶⁾ See "Junction Temperature Sense" section for details.

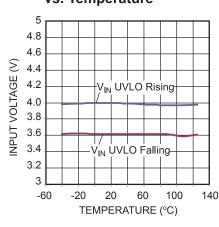




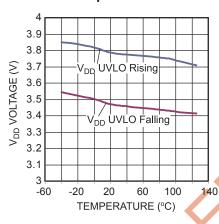


TYPICAL CHARACTERISTICS

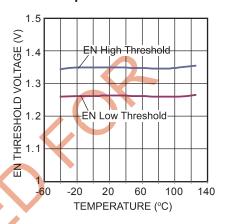
V_{IN} UVLO Threshold vs. Temperature



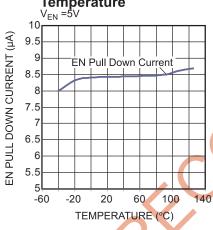
V_{DD} UVLO Threshold vs. Temperature



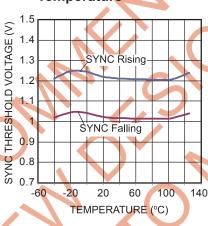
EN Threshold vs. Temperature



EN Pull Down Current vs. **Temperature**

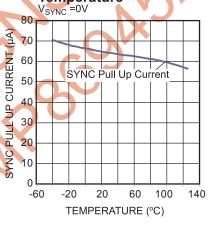


SYNC Threhold vs. **Temperature**

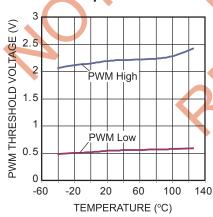


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SYNC Pull Up Current vs. Temperature



PWM Threshold vs. Temperature



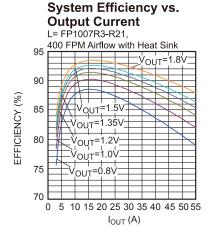
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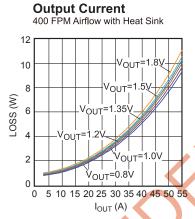


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

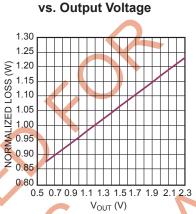
 V_{IN} =12V, V_{OUT} =1.2V, V_{DRV} = V_{DD} =5V, L=215nH, F_{SW} =600kHz, T_{A} =25°C, no droop, unless otherwise noted.

Device Loss vs.

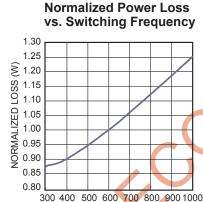




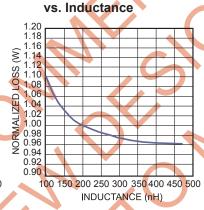
Normalized Power Loss

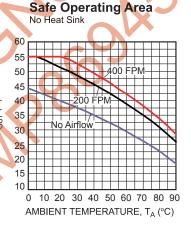


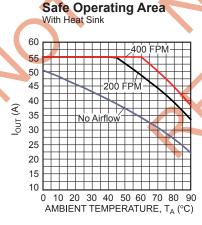
Normalized Power Loss



F_{SW} (kHz)









PIN FUNCTIONS

Pin#	Name	Description
1-6	SW	Switch Output.
7	VDRV	Driver Voltage. Connect to 5V supply and decouple with $1\mu F$ to $4.7\mu F$ ceramic capacitor.
8-21	PGND	Power Ground.
22-23	IN	Supply Voltage. Place C _{IN} close to the device to prevent large voltage spikes at the input.
24	EN	Enable. Pull low to place SW in a high impedance state.
25	VTEMP	Single pin temperature sense output.
26	FAULT#	Fault reporting on HS current limit, Over Temperature and VDD UVLO. It is an open drain output during normal operation and pull-low when fault occurred.
27	T1	Test pin. Connect to ground.
28	CS	Current Sense Output. Requires an external resistor.
29	RIN	Current Sense High Side Current Compensation pin. Connect through a resistor to IN.
30	AGND	Analog Ground.
31	VDD	Internal Circuitry Voltage. Connect to VDRV thru 2.2Ω resistor and decouple with 1μF capacitor to AGND. Connect AGND and PGND at this point.
32	PWM	Pulse Width Modulation. Leave PWM floating or drive to mid-state to put SW in high impedance state.
33	SYNC	Synchronous Low Switch. Leave open or pull high to enable. Pull low to enter diode emulation mode.
34	BST	Bootstrap. Requires a 0.22µF to 1µF capacitor to drive the power switch's gate above the supply voltage. Connects between SW and BST pins to form a floating supply across the power switch driver.



BLOCK DIAGRAM

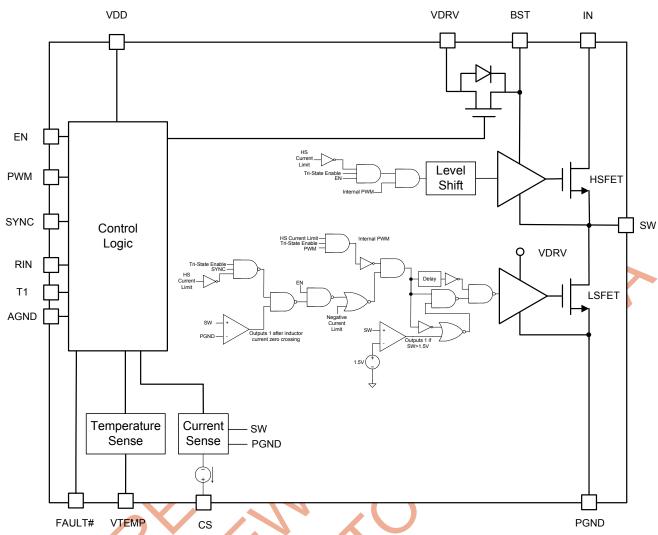


Figure 1: Functional Block Diagram

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OPERATION

The MP86883 is a 55A monolithic half-bridge driver with MOSFETs ideally suited for multiphase buck regulators.

When the EN transitions from low to high and both V_{DD} and V_{BST} signals are sufficiently high, operation begins. It is recommended to use EN pin to startup and shutdown the Intelli-Phase.

To put SW node in a high impedance state, let PWM pin float or drive PWM pin to mid-state. Drive the SYNC pin low to enter diode emulation mode. In diode emulation mode, the LSFET is off after inductor current crossed zero current.

When HSFET over current is detected, the part will latch off. Recycling Vdd or toggling EN will release the latch and restart the device. When the LSFET detects a -30A current, the part will turn off the LSFET for that cycle.

When Intelli-Phase detects over temperature, it will turn off both HS and LS MOSFET and latch off. Toggle Vdd or EN to restart the device.

Current Sense

The CS pin is a bi-directional current source proportional to the inductor current. Use the following equations to select the RIN resistance to connect between RIN pin and IN pin:

$$R_{\text{IN}} = -7.55 \times I_{\text{L_RIPPLE}} + 170 (k\Omega)$$

$$I_{L_RIPPLE} = \frac{t_{ON} \times (V_{IN} - V_{OUT})}{L} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times F_{SW} \times L}$$

Where I_{L RIPPLE} is the peak to peak inductor ripple current. For example, if the ripple current is 10A, then the calculated R_{IN} is 94.5k Ω and 95.3k Ω (the closest 1% resistor value) should be selected for R_{IN} .

The current sense gain is 10µA/A. In general, there is a resistor, R_{CS}, connected from CS pin and V_{OUT} or an external voltage which is capable to sink small current to provide enough voltage shift to meet the operating voltage on CS pin.

The CS voltage range of 1V to 3.5V is required to keep CS's output current linearly proportional to inductor current. Use the following equations to determine a proper reference voltage and/or R_{CS} value:

$$1V < I_{CS} \times R_{CS} + V_{REF} < 3.5V$$

$$I_{CS} = I_{L} \times 10 \times 10^{-6}$$

Intelli-Phase's current sense output can be used by controller to accurately monitor the output current. The cycle-by-cycle current information from CS pin can be used for phase current balancing, over current protection and active voltage positioning (output voltage droop).

Intelli-Phase's accurate current sense can replace traditional inductor DCR current sensing scheme. In traditional inductor DCR current sense:

$$V_{CS} = I_L \times R_{DCR}$$

With Intelli-Phase's CS output, Vcs becomes:

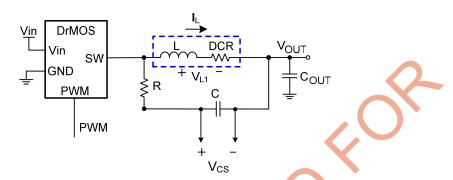
$$V_{CS} = I_{CS} \times R_{CS} = I_L \times R_{CS} \times 10 \times 10^{-6}$$

Where the RDCR term is with $R_{cs} \times 10 \times 10^{-6}$. Figure 2 shows a circuit replacing inductor DCR sensing with Intelli-Phase's CS output. There are several advantages with this current sensing method:

- Since current sensing is done by Intelli-Phase, user can select low DCR inductors and still have large current sense signal by selecting larger R_{CS}.
- 2. Tight DCR variation is not required.
- 3. CS signal is independent of impedance matching and inductor temperature.



Inductor DCR Current Sense



Intelli-Phase Current Sense

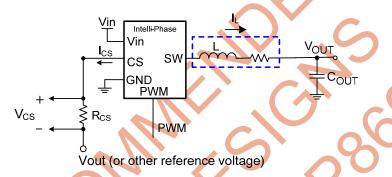


Figure 2: Replacing DCR Current Sense with Intelli-Phase's CS Output

Junction Temperature Sense

The VTEMP pin is a voltage output proportional to the junction temperature. The junction temperature can be calculated from the following equation:

$$T_{\text{JUNCTION}} = \frac{\left(V_{\text{TEMP}} + 100\text{mV}\right)}{\frac{10\text{mV}}{^{\circ}\text{C}}}$$
for $T_{\text{JUNCTION}} > 10^{\circ}\text{C}$

For example, if the VTEMP voltage is 700mV, then the junction temperature of Intelli-Phase is 80°C. VTEMP can not go below 0V, so it will read 0V for junction temperature lower than 10°C.

Be sure to measure this voltage between VTEMP and AGND pins for the most accurate reading. In multi-phase operation, the VTEMP pins of every Intelli-Phase can be connected to the temperature monitor pin of the controller. A sample circuitry is shown in Figure 3. VTEMP signals can also be used for system thermal protection as shown in Figure 4.



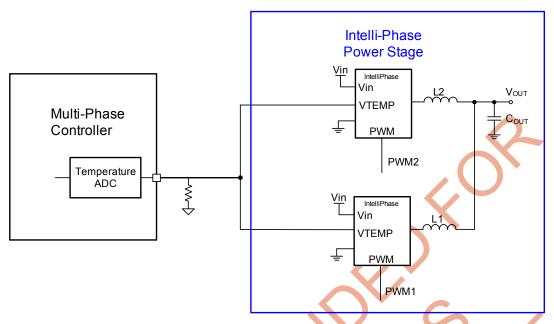


Figure 3: Multi-Phase Temperature Sense Utilization

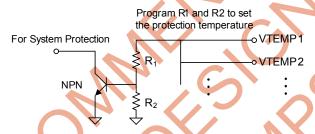
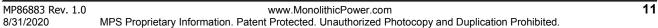


Figure 4: System Thermal Protection



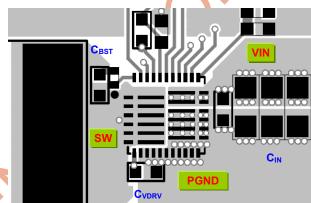


PCB Layout Guide Line

PCB layout plays an important role to achieve stable operation. For optimal performance, follow these guidelines.

- Always place some input bypass ceramic capacitors next to the device and on the same layer as the device. Do not put all of the input bypass capacitors on the back side of the device. Use as many via and input voltage planes as possible to reduce switching spikes. Place the BST capacitor and the VDRV capacitor as close to the device as possible.
- Place the VDD decoupling capacitor close to the device. Connect AGND and PGND at the point of VDD capacitor's ground connection.
- 3. It is recommended to use 0.22μF to 1μF bootstrap capacitor and 3.3Ω bootstrap resistance. Do not use capacitance values below 100nF for the BST capacitor.

- Connect IN, SW and PGND to large copper areas and use via to cool the chip to improve thermal performance and long-term reliability.
- 5. Keep the path of switching current short and minimize the loop area formed by the input capacitor. Keep the connection between the SW pin and the input power ground as short and wide as possible.





TYPICAL APPLICATION CIRCUITS

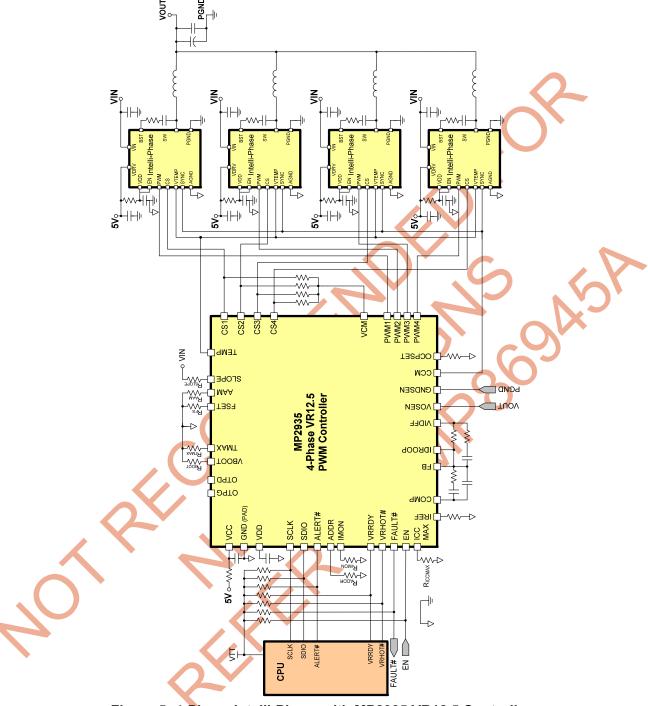
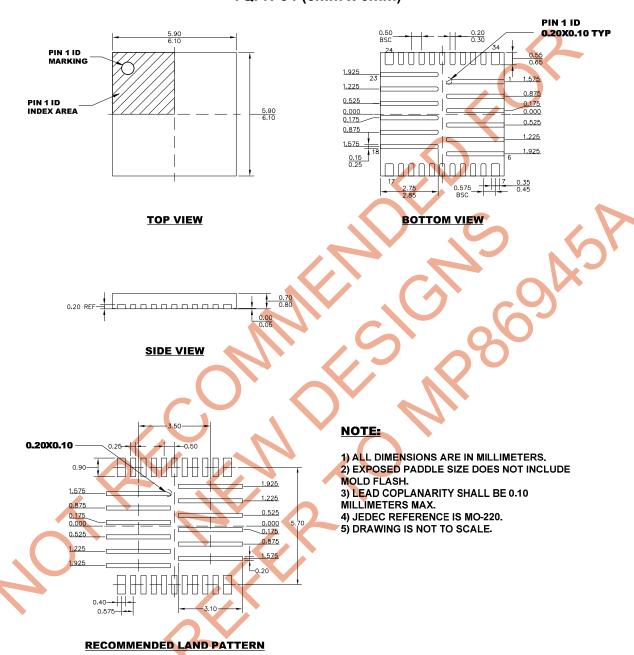


Figure 5: 4-Phase Intelli-Phase with MP2935 VR12.5 Controller



PACKAGE INFORMATION

TQFN-34 (6mm x 6mm)



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